

REV.	ECN NO	LOCATIONS	DESCRIPTION	DATE	REVISER	APPD
A						

Note:
 1. Specification:
 1.1 Voltage Rating: 50V
 1.2 Current rating: 1 A Max.
 1.3 Dielectric withstanding voltage: 250 V(ac) for 1 min
 1.4 Contact resistance: 50 mΩ Max.
 1.5 Insulation resistance: 1000 MΩ Min.
 1.6 Durability: 3000 Cycles
 1.7 Temperature range: -30°C~80°C

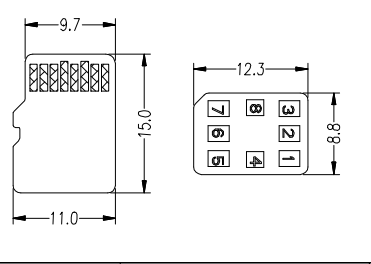
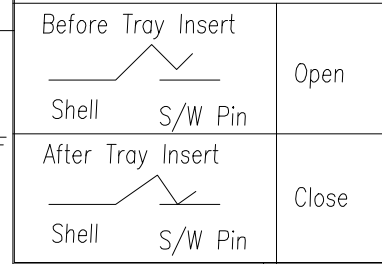
禁止布线!

Recommended PCB Layout

Nano Sim卡 Pin脚定义 TF卡 Pin脚定义

No.	描述	No.	描述
6P	Vcc	T1	DAT2
P1	RST	T2	CD/DAT3
P2	CLK	T3	CMO
P3	Reserved	T4	VDD
P5	GND	T5	CLK
P6	Vpp	T6	Vss
P7	I/O	T7	DAT0
P8	Reserved	T8	DAT1

5	Nail	Copper alloy	None
4	Spin Axis	Sus301 T=0.40	None
3	Shell	Sus301 T=0.12	50u"Min. Ni underplated all;1~3u"Min.Au plated solder Legs
2	Contact	C5210 T=0.10	50u"Min. Ni underplated all;1~3u"Min.Au plated Contact Area&Soldertails
1	Housing	LCP S475;Black	UL 94V-0
No.	Name	Material	Finish



DWG NO:	ST21-B11012-08	MATERIAL:	See note
MODEL NO:		FINISH:	See note
UNIT:	mm	SIZE:	A4
TOLERANCE UNSPECIFIED		DR:	胡志伟
.x	±0.10	CHK:	
.xx	±0.05	APP:	
.xxx	±0.03		
ANG.	±1°		

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TITLE: **三选二(双Nano Sim卡+TF卡)1.35H**

PART NO: **XDSM-1035-08** REV: A

SCALE: 1:1 SHEET: 1/1